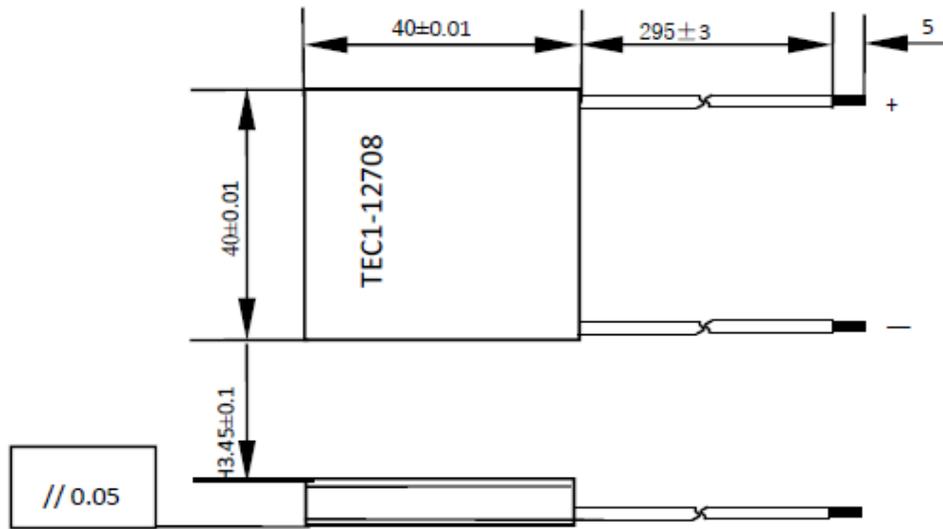


TEC112708



Product standards	Complies with international ROHS standards
Operating temperature range	-55-80°C
Maximum current (TH30 °C)	8.31A
Maximum voltage (TH30 °C)	15.4V
Maximum cooling power	73.29W
Porcelain chip specifications	40x40x0.76+0.4
Solder requirements	B58-138°C
Component specifications	PNP710N115-140115
Component logarithm	126
Overall dimensions	40x40x3.45±0.1
Lead wire requirements	Solder silicone wire 20 # with a length of 300mm and a peeling of 4mm
Sealing requirements	Sealing 704 silicone
Temperature difference range (TH30 °C)	≥67°C
Resistance range (TH30 °C)	1.5-1.65Ω
Packaging standards	Foam box shockproof packaging plus corrugated carton